



Mighty Gecko Mesh Networking Module Family

MGM111 Errata



This document contains information on the errata of revision V1 and V2 of MGM111.

For errata on older revisions, please refer to the errata history for the device. The device data sheet explains how to identify chip or module revision, either from package marking or electronically.

Errata effective date: September 8th, 2016.

1. Errata Summary

Table 1.1. Errata Status Summary

Errata #	Designator	Title/Problem	Workaround	Affected	Resolution
			Exists	Revision	
1	RADIO_E202	802.15.4 Channel 14	No	V1 and V2	—
2	ADC_E202	Wait After POR or EM4S Wakeup	Yes	V1 and V2	—
3	ADC_E206	PROGERRIF (Program Error Interrupt Flag) Will Not Clear	Yes	V1 and V2	—
4	ADC_E207	ADC Scan Repeat Mode with APORT	No	V1 and V2	—
5	ADC_E208	ADC Interrupt Flags	Yes	V1 and V2	—
6	ADC_E209	ADC and PRS Triggers	Yes	V1 and V2	—
7	ADC_E210	ADC with PRS and Software Triggers	Yes	V1 and V2	—
8	ADC_E211	ADC Single Repeat Mode and Tailgating	No	V1 and V2	—
9	ADC_E212	ADC with PRS in ASYNC Mode	Yes	V1 and V2	—
10	ADC_E213	ADC KEEPINSLOWACC Mode	No	V1 and V2	—
11	ADC_E214	Using ADC CHCONMODE with PRS	Yes	V1 and V2	—
12	ADC_E215	ADC CHCONMODE Set to MAXRESP Causes Extra Latency	Yes	V1 and V2	—
13	ADC_E216	ADC Conversion Start Delay	Yes	V1 and V2	—
14	ADC_E217	Multiple CLK Mode Switches	Yes	V1 and V2	—
15	ADC_E218	SINGLEACT and SCANACT Status Flags Delayed	Yes	V1 and V2	—
16	ADC_E219	STOP Command Causing FIFO Corruption	Yes	V1 and V2	—
17	ADC_E220	AUXHFRCO in ASYNC mode with ASYNC CLK in ASNEEDED mode	Yes	V1 and V2	—
18	ADC_E221	ADC Temperature Sensor Must be Used in LOWACC Mode	Yes	V1 and V2	—
19	ADC_E222	ADC EM2 Wakeup on a Comparator Match Disables EM2 Entry	Yes	V1 and V2	—
20	ADC_E223	Delayed ADC Conversion or Warmup Start	Yes	V1 and V2	—
21	CORE_E201	SYSTICK and an External Clock	Yes	V1 and V2	—
22	DBG_E201	AUXHFRCO Debug Limitations	Yes	V1 and V2	—
23	DBG_E202	Debug Access to ADC and LEUART not Functioning as Intended	No	V1 and V2	—
24	EFR_E201	Bit Access Not Supported for Low Energy Peripherals	Yes	V1 and V2	—
25	EFR_E202	Read-Clear Access for LETIMER0 and RTCC Interrupts	Yes	V1 and V2	—
26	EMU_E201	High Temperature Operation	Yes	V1 and V2	—
27	EMU_E204	Restrictions Writing TEMPHIGH and TEMPLOW	Yes	V1 and V2	—
28	EMU_E205	Restrictions Reading TEMP	Yes	V1 and V2	—
29	EMU_E207	GPIO State can be Lost During EM4 Recovery	Yes	V1 and V2	—

Errata #	Designator	Title/Problem	Workaround Exists	Affected Revision	Resolution
30	EMU_E208	Occasional Full Reset After Exiting EM4H	Yes	V1 and V2	—
31	EMU_E209	Potential EM2 Lock-up when using IDAC or the Debugger with the LDMA	Yes	V1 and V2	—
32	EMU_E210	Potential Power-Down When Entering EM2	Yes	V1 and V2	—
33	IDAC_E201	IDAC CURSTABLE Bit Not Reliable	Yes	V1 and V2	—
34	I2C_E201	I2C ABORT Command	Yes	V1 and V2	—
35	LEUART_E201	Restrictions Setting TXDMAWU/RXDMAWU of LEUARTn_CTRL	Yes	V1 and V2	—
36	RTCC_E201	RTCC Does Not Support Compare/Capture Wrap with Prescaler	Yes	V1 and V2	—
37	RTCC_E202	RTCC Triggers to LETIMER Not Safe	Yes	V1 and V2	—
38	TIMER_E201	Timer in Input Capture Mode Can Stop Counting	Yes	V1 and V2	—
39	FLASH_E201	Potential Program Failure after Power On	Yes	V1 and V2	—
40	RMU_E201	CTRL Register Reset on All Resets	Yes	V1 and V2	—

2. Detailed Errata Descriptions

2.1 RADIO_E202 – 802.15.4 Channel 14

Description of Errata
Receive sensitivity of 802.15.4 channel 14 is lower than expected. The average receive sensitivity of 802.15.4 channel 14 is currently –98 dBm.
Affected Conditions / Impacts
The average receive sensitivity of 802.15.4 channel 14 is currently lower than expected.
Workaround
There is currently no workaround for this issue.
Resolution
There is currently no resolution for this issue.

2.2 ADC_E202 – Wait After POR or EM4S Wakeup

Description of Errata
Attempting to take an ADC sample too soon after POR or EM4S wakeup can result in an erroneous sample being returned by the ADC.
Affected Conditions / Impacts
ADC can return erroneous sample data.
Workaround
After POR or EM4S wakeup, users must wait 150 μ s before starting and using the ADC.
Resolution
There is currently no resolution for this issue.

2.3 ADC_E206 – PROGERRIF (Program Error Interrupt Flag) Will Not Clear

Description of Errata
If an invalid selection is made on APORT via POSSEL or NEGSEL by selecting both POSSEL and NEGSEL on the X bus or both on the Y bus, then PROGERRIF will set to 1. If this is followed by a valid internal selection (POSSEL set to AVDD and NEGSEL set to VSS), the PROGERRIF flag will remain 1, even though the selection is valid. This PROGERRIF flag can only be cleared by first making a valid selection of the APORT channels, then moving to an internal selection.
Affected Conditions / Impacts
If firmware attempts to clear the PROGERRIF error condition by selecting a valid non-APORT channel, the PROGERRIF bit will remain set to 1 even after firmware attempts to clear the flag.
Workaround
Firmware can clear the flag by first making a valid selection on POSSEL/NEGSEL to an APORT channel before moving to an internal selection.
Resolution
There is currently no resolution for this issue.

2.4 ADC_E207 – ADC Scan Repeat Mode with APORT

Description of Errata
If Scan repeat mode is enabled, then the ADC sets the correct APORT settings only on the first scan sequence conversion. APORT settings are cleared for all subsequent scan sequence conversions.
Affected Conditions / Impacts
Scan repeat mode does not work with the APORT.
Workaround
There is no known workaround for this issue.
Resolution
There is currently no resolution for this issue.

2.5 ADC_E208 – ADC Interrupt Flags

Description of Errata
The SCANCMP and SINGLECMP interrupt flags in ADCn_IF are not clearable in certain scenarios. These interrupts can trigger multiple times on the same event if the event conditions are not cleared before clearing the interrupt flags.
Affected Conditions / Impacts
Multiple SCANCMP or SINGLECMP interrupts can occur from the same source.
Workaround
Once an interrupt is received, either disable the compare logic (clear CMPEN in ADCn_SINGLECTRL or ADCn_SCANCTRL) or clear the FIFO (using ADCn_SINGLEFIFOCLEAR or ADCn_SCANFIFOCLEAR) before clearing the interrupt flags.
Resolution
There is currently no resolution for this issue.

2.6 ADC_E209 – ADC and PRS Triggers

Description of Errata
Scan conversions may become dependent on Single triggers, and vice versa. If both Scan and Single channel mode are set to PRS Timed mode and both Scan and Single triggers are high at the same time before the approximation phase has started, the conversion is halted until both PRS triggers occur.
Affected Conditions / Impacts
A Scan conversion can end up waiting for a Single PRS trigger to go low before it starts the approximation phase, even if the Scan PRS trigger has already gone low, and vice versa.
Workaround
Do not set both ADC Single and Scan to use PRS Timed mode at the same time. Alternatively, if they are both set to use PRS Timed mode simultaneously, ensure that both PRS timed pulses are never high at the same time.
Resolution
There is currently no resolution for this issue.

2.7 ADC_E210 – ADC with PRS and Software Triggers

Description of Errata
<p>Software triggered conversions are affected if the ADC is set to use PRS Timed mode, even when PRSEN is 0. If PRS Timed mode is selected using PRSMODE in ADCn_SCANCTRLX, regardless of what is set in PRSEN:</p> <ol style="list-style-type: none"> 1. All channels in the scan sequence (except the first one) experience an additional 2 raw ADC_CLK cycle latency in the conversion. The same 2 cycle latency will be experienced in all subsequent conversions in repeat mode and conversions done due to oversampling in both single and scan mode. 2. If the software triggers a conversion and a PRS pulse comes in before the conversion has passed the acquisition phase, the software-triggered conversion will stall and wait for the PRS pulse to go low before starting the approximation phase.
Affected Conditions / Impacts
<p>When using the PRS Timed mode with ADC scan, the overall scan conversion time will be longer than expected by:</p> <p>Extra ADC_CLK Cycles = $2 \times (\text{number of channels scanned} - 1)$</p> <p>In addition, 1 MSPS sampling will not be reachable with a software trigger, and software triggers may experience a dependency on the PRS triggers.</p>
Workaround
<p>There is currently no workaround for extra clocks generated by PRS Timed mode. When doing software triggered conversions, do not select PRS Timed mode in PRSMODE.</p>
Resolution
<p>There is currently no resolution for this issue.</p>

2.8 ADC_E211 – ADC Single Repeat Mode and Tailgating

Description of Errata
<p>If the ADC Single repetitive mode is enabled using REP in ADCn_SINGLECTRL and tailgating is enabled by setting TAILGATE in ADCn_CTRL, then the ADC waits for first Scan conversion. Once that completes, a Single conversion starts, but it is stopped by the ADC before it is complete.</p>
Affected Conditions / Impacts
<p>Single repeat mode does not work with tailgating enabled.</p>
Workaround
<p>There is currently no workaround for this issue.</p>
Resolution
<p>There is currently no resolution for this issue.</p>

2.9 ADC_E212 – ADC with PRS in ASYNC Mode

Description of Errata
<p>The ADC is currently documented as an asynchronous PRS producer. However, when the ADC is setup in ASYNC mode (ADCCLKMODE in ADCn_CTRL is set to ASYNC), the PRS outputs are no longer synchronous to the HPPERCLK.</p>
Affected Conditions / Impacts
<p>The ADC PRS outputs will not be properly synchronized when the ADC is in ASYNC mode.</p>
Workaround
<p>Use the ADC PRS outputs only when the ADC is setup to use SYNC mode (ADCCLKMODE in ADCn_CTRL is set to SYNC).</p>
Resolution
<p>There is currently no resolution for this issue.</p>

2.10 ADC_E213 – ADC KEEPINSLOWACC Mode

Description of Errata
When WARMUP-MODE in ADCn_CTRL is set to KEEPINSLOWACC, the ADC does not track the input voltage. Also, the ADC keeps the input muxes closed even during channel switching, making it unsafe to operate the ADC in KEEPINSLOWACC mode.
Affected Conditions / Impacts
KEEPINSLOWACC warmup mode does not work.
Workaround
There is currently no workaround for this issue.
Resolution
There is currently no resolution for this issue.

2.11 ADC_E214 – Using ADC CHCONMODE with PRS

Description of Errata
When CHCONMODE in ADCn_CTRL is set MAXRESP, the ADC does not work with PRS Timed mode.
Affected Conditions / Impacts
If the PRS pulse is longer than the ADC acquisition time, the input mux select lines are switched during the acquisition phase, causing the results to no longer be usable.
Workaround
PRS Timed mode should not be used with CHCONMODE in ADCn_CTRL set to MAXRESP.
Resolution
There is currently no resolution for this issue.

2.12 ADC_E215 – ADC CHCONMODE Set to MAXRESP Causes Extra Latency

Description of Errata
Setting CHCONMODE in ADCn_CTRL to MAXRESP introduces 7 extra raw ADC_CLK cycles of latency between scan conversions in a sequence.
Affected Conditions / Impacts
The 7 raw ADC_CLK cycles of extra latency impacts the time the sample is taken.
Workaround
Use CHCONMODE set to MAXSETTLE in order to avoid the extra latency.
Resolution
There is currently no resolution for this issue.

2.13 ADC_E216 – ADC Conversion Start Delay

Description of Errata
If CONVSTARTDELAYEN in both SINGLECTRLX and SCANCTRLX registers are set to 1, the ADC will look at CONVSTARTDELAY value set in SINGLECTRLX register regardless of the conversion type (SCAN or SINGLE). If a SCAN conversion is triggered in this scenario, the conversion will be delayed for the value specified in SINGLECTRLX. In all other cases, the ADC behaves as expected.
Affected Conditions / Impacts
Enabling both SINGLE and SCAN conversion start delay can result in unexpected behavior if the delay selection in the SINGLE and SCAN registers is different.
Workaround
If different CONVSTARTDELAY values are desired for SCAN and SINGLE, do not keep both SINGLE CONVSTARTDELAY and SCAN CONVSTARTDELAY enabled at the same time.
Resolution
There is currently no resolution for this issue.

2.14 ADC_E217 – Multiple CLK Mode Switches

Description of Errata
This issue can be encountered if the ADC clock (CLK) mode switches between asynchronous (ASYNC) and synchronous (SYNC) while data is being read. Specifically, this issue can occur if ADC operates in ASYNC mode with converted data being read, then some conversions are done in SYNC mode before being switched back to ASYNC mode again. FIFOCOUNT may show the wrong value when read in ASYNC mode after the last clock mode switch. Note that the recommended procedure for switching CLK modes should always be followed.
Affected Conditions / Impacts
An unexpected value may be read from FIFOCOUNT registers.
Workaround
When switching from SYNC to ASYNC mode more than once, clear the FIFOs using FIFOCLEAR before and after the CLK mode switch.
Resolution
There is currently no resolution for this issue.

2.15 ADC_E218 – SINGLEACT and SCANACT Status Flags Delayed

Description of Errata
Once the SINGELSTART/SCANSTART commands are issued, it takes a few cycles before the ADC SINGLEACT/SCANACT status flags are set.
Affected Conditions / Impacts
The status flags cannot be checked right after the conversion start commands are issued.
Workaround
Firmware that wants to check when a conversion has started after sending a software trigger will need to wait until the corresponding status flag (SINGELACT/SCANACT) goes high before proceeding.
Resolution
There is currently no resolution for this issue.

2.16 ADC_E219 – STOP Command Causing FIFO Corruption

Description of Errata
If a single or scan conversion is running and a software STOP command is issued, the conversion should stop immediately and the result should be discarded (no FIFO updates should happen). Currently in the ADC, if a single (scan) conversion is stopped by a software STOP command and there is a scan (single) conversion pending, then the conversion will incorrectly continue and the result will be used to update the FIFO.
Affected Conditions / Impacts
Issuing the STOP command can have two different effects. If the command is sent during a conversion, the effect will be immediate if no other conversion is pending. The immediate effect means stopping the on-going conversion and discarding the current sample. If the command is sent during a conversion, the on-going conversion will finish, and the current sample will be saved into the corresponding FIFO. This means that the single conversion will fully finish (regardless of the ADC mode, e.g. if in the oversampling mode, the full oversampling will be executed, or if in the repetition mode, the current conversion will finish and then the repetition mode for single will be disabled) and that the scan conversion will fully finish conversion of the current channel, but it will not finish the whole scan sequence (regardless of the ADC mode). In the last case, the scan FIFO will be updated with the data from channels converted so far.
Workaround
If using the STOP command, the effect will be immediate if no scan triggers were pending during the single conversion and vice versa.
Resolution
There is currently no resolution for this issue.

2.17 ADC_E220 – AUXHFRCO in ASYNC mode with ASYNC CLK in ASNEEDED mode

Description of Errata
ADC sampling in the ASYNC ASNEEDED mode when running from the AUXHFRCO can temporarily upset voltage references used in certain analog components. This issue effects the BOD trip point, DCDC voltage accuracy, ACMP reference accuracy, IDAC output current accuracy, and low voltage digital supply voltage accuracy.
Affected Conditions / Impacts
If the ADC is being used in ASYNC mode with AUXHFRCO, ASYNC CLK cannot be used in ASNEEDED mode.
Workaround
If the ADC is being used in ASYNC mode with AUXHFRCO, ASYNC CLK must be set to ALWAYS ON mode.
Resolution
There is currently no resolution for this issue.

2.18 ADC_E221 – ADC Temperature Sensor Must be Used in LOWACC Mode

Description of Errata
The ADC temperature sensor used in HIGHACC mode can temporarily upset voltage references used in certain analog components. This issue affects the BOD trip point, DCDC voltage accuracy, ACMP reference accuracy, IDAC output current accuracy, and low voltage digital supply voltage accuracy.
Affected Conditions / Impacts
If the ADC is being used to take a reading from its internal temperature sensor, ADCn_BIASPROG.GPBIASACC = 0 cannot be used.
Workaround
Use ADCn_BIASPROG.GPBIASACC = 1 when taking temperature measurements.
Resolution
There is currently no resolution for this issue.

2.19 ADC_E222 – ADC EM2 Wakeup on a Comparator Match Disables EM2 Entry

Description of Errata
If the ADC wakes up the system from EM2 on a comparator flag match (CMPEN must be set in SINGLECTRL/SCANCTRL), the wake-up handler will not be able to clear this EM2 wakeup request. This results in the core immediately exiting EM2 on subsequent EM2 entry.
Affected Conditions / Impacts
Systems using the ADC comparator flag match may not be able to enter EM2.
Workaround
To clear the wakeup request, the wakeup handler must do one of the following: <ul style="list-style-type: none"> • Disable CMPEN in the SINGLECTRL/SCANCTRL register. • Reset the ADC FIFO. • Continue performing conversions until an incoming conversion does not pass the CMP threshold set in CMPTHR. Once one of these conditions has been met, the comparator can be re-enabled and the core can enter EM2.
Resolution
There is currently no resolution for this issue.

2.20 ADC_E223 – Delayed ADC Conversion or Warmup Start

Description of Errata
<p>When a new conversion trigger is received from PRS or a software start, the ADC is expected to either:</p> <ol style="list-style-type: none"> 1. Immediately start warmup (if ADCn_CTRL_WARMUPMODE is set to NORMAL, KEEPINSTANDBY, or KEEPINSLOWACC). 2. Immediately start the conversion (if in KEEPADCWARM warmup mode). <p>This expected behavior does not occur if the ADC prescaler (ADCn_CTRL_PRESC) is set to a non-zero value, as the start of the ADC warmup or conversion gets delayed by the number of ADC clock cycles specified by the PRESC field.</p>
Affected Conditions / Impacts
Systems using the ADC clock prescaler will see a delay after a start-of-conversion or start-of-warmup trigger and the actual conversion or warmup sequence.
Workaround
For systems that cannot tolerate a delay between the start-of-conversion and actual conversion or before ADC warmup, set ADCn_CTRL_PRESC to 0 and use the prescalars in the CMU to prescale the incoming ADC_CLK.
Resolution
There is currently no resolution for this issue.

2.21 CORE_E201 – SYSTICK and an External Clock

Description of Errata
The core allows two different clock sources for the SysTick counter. The first one is the core free-running clock, which operates correctly. The second source uses the 32 kHz from the RTCC. This pulse width of this clock is not wide enough, which results in missed SysTick counts.
Affected Conditions / Impacts
Firmware should not use the external clock source for the SysTick counter.
Workaround
Use the core free-running clock for the SysTick, which is the default selection.
Resolution
There is currently no resolution for this issue.

2.22 DBG_E201 – AUXHFRCO Debug Limitations

Description of Errata
The AUXHFRCO is the default debug clock, set by DBG in CMU_DBGCLKSEL. Using AUXHFRCO as the debug clock while entering EM2 has the potential of corrupting the system, causing some registers in the TPIU to not retain their value.
Affected Conditions / Impacts
Firmware should not use the AUXHFRCO as the debug clock while entering EM2.
Workaround
When using AUXHFRCO as the debug clock, it must be stopped before entering the EM2 power mode. Alternatively, select another clock source as the debug clock before entering EM2.
Resolution
There is currently no resolution for this issue.

2.23 DBG_E202 – Debug Access to ADC and LEUART not Functioning as Intended

Description of Errata
ADC and LEUART registers that have a side-effect during a read access (i.e., LEUART_RXDATA or other registers that pop data read) continue to execute triggered actions when an attached debugger is performing read accesses. The intended behavior is to halt execution of pop actions when a debugger is attached.
Affected Conditions / Impacts
Some ADC and LEAURT registers will pop data from their respective buffers on read accesses from the debugger.
Workaround
The user needs to be aware that while debugging, reads via the debugger have the same affect as reads by the CPU during normal mode for these registers. To avoid the debugger triggering a data pop from the buffer, the user should avoid setting a memory window over the actionable register(s), as the reads to fetch the data for the debugger memory view would trigger the data pop from the buffer.
Resolution
There is currently no resolution for this issue.

2.24 EFR_E201 – Bit Access Not Supported for Low Energy Peripherals

Description of Errata
Bit set and clear operations do not work properly for Low Energy Peripherals including WDOG, PCNT0, LEUART0, LETIMER0, and RTCC.
Affected Conditions / Impacts
To implement bit set or bit clear operations with Low Energy Peripherals, firmware must execute a read-modify-write operation address on the peripheral's registers.
Workaround
To implement bit set or bit clear operations with Low Energy Peripherals (WDOG, PCNT0, LEUART0, LETIMER0, and RTCC), firmware must execute a read-modify-write operation address on the peripheral's registers.
Resolution
There is currently no resolution for this issue.

2.25 EFR_E202 – Read-Clear Access for LETIMER0 and RTCC Interrupts

Description of Errata
The automatic read-clear mechanism for the LETIMER0 and RTCC modules does not actually clear the module interrupts.
Affected Conditions / Impacts
Firmware must be written to manually clear the interrupts for the LETIMER0 and RTCC modules.
Workaround
Firmware must read the LETIMER0 and RTCC interrupts using the module IFS register and clear the interrupts manually by writing to the module IFC register.
Resolution
There is currently no resolution for this issue.

2.26 EMU_E201 – High Temperature Operation

Description of Errata
<p>The performance of analog peripherals at high temperatures (above 50 °C) may change over time. Firmware should periodically adjust the calibration of the analog peripherals to compensate for this behavior.</p> <p>This issue affects the BOD trip point, dc-dc output voltage accuracy, ACMP reference accuracy, and IDAC output current accuracy in EM2 through EM4H power modes. This does not affect operation of these peripherals in the EM0, EM1, or EM4S power modes.</p>
Affected Conditions / Impacts
The performance of analog peripherals at high temperatures may change over time.
Workaround
<p>The TEMPDRV module in emdrv addresses this issue and should be included in application firmware. This module is automatically included for systems using Silicon Labs software stacks. For systems not using a Silicon Labs stack (i.e., writing code from scratch or using software examples as a starting point), firmware should include the TEMPDRV module and call the <code>TEMPDRV_Init()</code> function to improve high temperature operation (above 50 °C). The module documentation can be found in Simplicity Studio and contains more information about the firmware solution.</p> <p>See <i>AN1027: EFR32xG1 and EFM32PG1/JG1 High-Temperature Operation</i> for more information.</p>
Resolution
There is currently no resolution for this issue.

2.27 EMU_E204 – Restrictions Writing TEMPHIGH and TEMPLOW

Description of Errata
Writing TEMPHIGH and TEMPLOW in EMU_TEMPLIMITS at certain times can cause erroneous interrupts to occur.
Affected Conditions / Impacts
Writing to TEMPHIGH or TEMPLOW in EMU_TEMPLIMITS at any time may cause the TEMPHIGH and TEMPLOW interrupt flags in EMU_IF to trigger incorrectly.
Workaround
Firmware should only write TEMPHIGH and TEMPLOW within 250 ms of receiving a TEMPLOW, TEMPHIGH, or TEMP interrupt.
Resolution
There is currently no resolution for this issue.

2.28 EMU_E205 – Restrictions Reading TEMP

Description of Errata
Reads of TEMP in EMU_TEMP may not always return the correct value.
Affected Conditions / Impacts
Reading TEMP in EMU_TEMP at any time may read an incorrect value.
Workaround
<p>Firmware should restrict its reading of TEMP to the following scenarios:</p> <ol style="list-style-type: none"> 1. Read the TEMP field multiple times until the same value is returned in two consecutive reads. 2. Read TEMP within 250 ms of receiving a TEMPLOW, TEMPHIGH, or TEMP interrupt.
Resolution
There is currently no resolution for this issue.

2.29 EMU_E207 – GPIO State can be Lost During EM4 Recovery

Description of Errata
Firmware can configure the I/O state to be retained when exiting EM4 by setting EM4IORETMODE in EMU_EM4CTRL. The desired behavior is that firmware can restore the state of the I/Os in EM0 after exit from EM4 via reset while the I/O state is maintained. It is possible for a GPIO saving a non-5 V tolerant (non-OVT) configuration pull-down configuration to lose the pull-down state if 5 V (OVT) tolerance is disabled using GPIO_Px_OVTDIS before restoring the pull-down configuration.
Affected Conditions / Impacts
Restoring the GPIO after an EM4 wakeup improperly can result in the I/O pull-down configuration being lost.
Workaround
The loss of the pull-down state can be avoided by re-enabling the pull-down before disabling the Over Voltage Tolerance for a GPIO using GPIO_Px_OVTDIS.
Resolution
There is currently no resolution for this issue.

2.30 EMU_E208 – Occasional Full Reset After Exiting EM4H

Description of Errata
Exiting EM4H may occasionally cause a full reset causing loss of RTCC counters and result in longer wakeup times on the order of power-on wakeup times.
Affected Conditions / Impacts
When waking up from EM4H, the system does not wait long enough for the BODs to settle before enabling it as a reset source. Even if the power is stable on DECOUPLE, AVDD, or DVDD, the part may see a BOD reset. The reset is reflected in the RESETCAUSE register.
Workaround
The work around is to disable the BOD prior to EM4H entry by doing the following sequence:
<pre>// Unlock access to emu test registers EMU->TESTLOCK = EMU_TESTLOCK_LOCKKEY_UNLOCK; // Mask the BOD outputs to avoid resets EMU->TESTCTRL = EMU_TESTCTRL_BOD_MASK;</pre>
The BODs will automatically be enabled after EM4H wakeup, but disabling the BOD will also result in disabling the EM4BOD protection. POR reset will still be valid. This work around is not needed for EM4S.
Resolution
There is currently no resolution for this issue.

2.31 EMU_E209 – Potential EM2 Lock-up when using IDAC or the Debugger with the LDMA

Description of Errata
The device can lock up if firmware updates the IDAC output just before entering EM2 while the DMA module is enabled. Similarly, the device can lock up if the Debugger is connected and the firmware enters EM2 while the DMA module is enabled.
Affected Conditions / Impacts
Systems using the DMA and IDAC or DMA and Debugger may no longer function properly after attempting to enter EM2.
Workaround
Two workarounds exist: <ol style="list-style-type: none"> 1. If DMA functionality in EM2 is not needed, firmware can disable the DMA via the CMU->HFBUSCLKEN* LDMA bit before entering EM2. 2. If DMA functionality in EM2 is needed, wait for the IDAC output to settle before entry into EM2 or disconnect the debugger before entry into EM2.
Resolution
There is currently no resolution for this issue.

2.32 EMU_E210 – Potential Power-Down When Entering EM2

Description of Errata
On the rare occasion when the firmware starts a transition to EM2 while the EMU is updating its Temperature Sensor measurement, and then within a 300 ns window of entering EM2 the system is woken up to EM0 or EM1, the device's internal power system can be erroneously disabled, powering down the device. When this occurs, the device will reset and will set the DECBOD flag in the RMU_RSTCAUSE register.
Affected Conditions / Impacts
Systems that do not use the emdrv TEMPDRV module may experience a power down on these very rare EM2 timing transitions.
Workaround
The TEMPDRV module in emdrv (SDK version v5.0.0 or later) addresses this issue and should be included in application firmware. This module is automatically included for systems using Silicon Labs software stacks. For systems not using a Silicon Labs stack (i.e., writing code from scratch or using software examples as a starting point), firmware should include the TEMPDRV module and call the <code>TEMPDRV_Init()</code> function to prevent this issue from occurring. The module documentation can be found in Simplicity Studio and contains more information about the firmware solution.
Resolution
There is currently no resolution for this issue.

2.33 IDAC_E201 – IDAC CURSTABLE Bit Not Reliable

Description of Errata
The IDAC CURSTABLE flag in IDAC_STATUS may erroneously report that the current output is stable.
Affected Conditions / Impacts
Systems using the IDAC should not rely on the CURSTABLE to determine if the output is stable.
Workaround
The CURSTABLE bit must not be used. Firmware must wait the minimum required IDAC settling time listed in the data sheet.
Resolution
There is currently no resolution for this issue.

2.34 I2C_E201 – I2C ABORT Command

Description of Errata
For on-going transactions, the ABORT command in I2Cn_CMD may cause the I2C module to lock up indefinitely if it is issued in the middle of an I2C transaction.
Affected Conditions / Impacts
During on-going transactions, the ABORT command can cause the I2C receive module FSM to hang, locking up the I2C transaction indefinitely.
Workaround
The ABORT command should only be used after the I2C module is enabled in order to instruct the I2C module that the bus is IDLE. To use the ABORT command during a transaction, the I2C module should be disabled by clearing EN in I2Cn_CTRL.
Resolution
There is currently no resolution for this issue.

2.35 LEUART_E201 – Restrictions Setting TXDMAWU/RXDMAWU of LEUARTn_CTRL

Description of Errata
Changing the value of TXDMAWU while TXEN = 1 or RXDMAWU while RXEN = 1 in LEUARTn_CMD could potentially cause unpredictable behavior.
Affected Conditions / Impacts
If the TXDMAWU field is updated while TXEN = 1 or the RXDMAWU field is updated while RXEN = 1, a spurious DMA wake-up event could be created.
Workaround
Firmware should first disable the receive or transmit path using RXEN or TXEN in LEAURTn_CMD before changing RXDMAWU or TXDMAWU.
Resolution
There is currently no resolution for this issue.

2.36 RTCC_E201 – RTCC Does Not Support Compare/Capture Wrap with Prescaler

Description of Errata
When the RTCC is configured with a prescaler, the CCV1 top value enable feature enabled by setting CCV1TOP in RTCC_CTRL fails to wrap the counter when RTCC_CNT is equal to RTCC_CC1_CCV, as intended.
Affected Conditions / Impacts
Using CCV1TOP with a prescaled RTCC may result in the RTCC not wrapping at the desired time.
Workaround
Do not use a prescaler with the RTCC when using the CCV1TOP feature.
Resolution
There is currently no resolution for this issue.

2.37 RTCC_E202 – RTCC Triggers to LETIMER Not Safe

Description of Errata
The LETIMER inputs from the RTCC are connected to the LFECLK domain, while the LETIMER itself is clocked from the LFACTK domain. This results in synchronization issues between the RTCC inputs to the LETIMER and the LETIMER.
Affected Conditions / Impacts
RTCC triggers to LETIMER are not safe and can result in undefined behavior.
Workaround
Do not use RTCC triggers for LETIMER. PRS channels can be used as an alternative.
Resolution
There is currently no resolution for this issue.

2.38 TIMER_E201 – Timer in Input Capture Mode Can Stop Counting

Description of Errata
When RISEA/FALLA is configured to RELOADSTART and then changed to any other mode at the same time as when a pulse from CC0 or PRS input occurs, the counter could stop running.
Affected Conditions / Impacts
The timer may not count properly in all situations.
Workaround
To prevent input pulses while changing RISEA/FALLA: <ol style="list-style-type: none"> 1. If using PRS, before changing RISEA/FALLA from RELOADSTART to any other value, change the input to some other PRS input by using PRSSEL in TIMERN_CC0_CTRL. After clearing RISEA/FALLA, set PRSSEL back to the original value 2. If using CC0 in, set GPIO mode to DISABLE for that pin before changing RISEA/FALLA. Then, set it back to INPUT mode after changing RISEA/FALLA.
Resolution
There is currently no resolution for this issue.

2.39 FLASH_E201 – Potential Program Failure after Power On

Description of Errata
There is very small probability that, with some devices, the first program of flash after a power on cycle or wake-up from EM2, EM3, EM4H, or EM4S may not take effect unless the flash has first been programmed or erased. This issue affects all devices, though the probability of the failure occurring on each device may differ.
Affected Conditions / Impacts
After a power-on, the first program of flash initiated by firmware may not take effect.
Workaround
To ensure the flash is programmed correctly, firmware should program the flash, verify the flash contents, and reprogram the flash, if necessary. This workaround is included in v4.4.0 or later of the Gecko SDK. Note that typical word (32-bit) programming time is 26 μ s, while it only takes several tens of ns to read and verify, so the overhead is minimal.
An alternative workaround is to erase the flash page before programming after a power on cycle or wake-up from EM2, EM3, EM4S, or EM4H.
Resolution
There is currently no resolution for this issue.

2.40 RMU_E201 – CTRL Register Reset on All Resets

Description of Errata
The RMU->CTRL register is reset to default state on every system reset, not only POR and hard pin reset as stated in the reference manual.
Affected Conditions / Impacts
The RMU->CTRL register is reset to default state on every system reset, not only POR and hard pin reset as stated in the reference manual.
Workaround
Firmware should always update RMU->CTRL after a reset. Note that the LOCKUP reset is disabled by default.
Resolution
There is currently no resolution for this issue.

3. Revision History

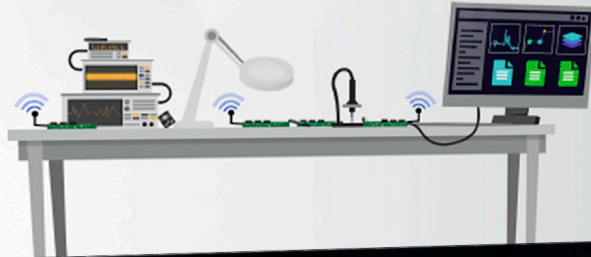
3.1 Revision 0.1

September 8th, 2016

Initial revision.

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